

CML9014-VB Datasheet

P-Channel 60-V (D-S) MOSFET

PRODU	ICT SUMMARY		
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)
- 60	0.055 at V _{GS} = - 10 V	- 7.0	30 nC
- 00	0.065 at V _{GS} = - 4.5 V	- 6.0	30110

FEATURES

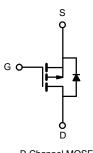
- Trench Power MOSFET
- 100 % UIS Tested

APPLICATIONS

Load Switch







P-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 60	ν.	
Gate-Source Voltage		V _{GS}	± 20	V	
	T _C = 25 °C		- 7.0 ^a		
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 70 °C		- 5.2		
Continuous Drain Current $(T_j = 150^{\circ} C)$	T _A = 25 °C	I _D	- 4.8 ^b	А	
	T _A = 70 °C		- 4.1 ^b	A	
Pulsed Drain Current		I _{DM}	- 25		
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	- 4.5		
Single Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	10.1	mJ	
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	6.9 ^a	А	
Continuous Source-Drain Diode Current	T _A = 25 °C	'S	3.5 ^b	A	
	T _C = 25 °C		10.4 ^a		
Maximum Power Dissipation	T _C = 70 °C	P _D	6.6 ^a	W	
	T _A = 25 °C	ГD —	2.1 ^b	vv	
	T _A = 70 °C		1.1 ^b		
Operating Junction and Storage Temperature R	ange	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS	i				
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	33	40	°C/W
Maximum Junction-to-Case	Steady State	R _{thJC}	0.98	1.2	C/VV

Notes:

a. Based on $T_C = 25 \ ^{\circ}C$.

b. Surface mounted on 1" x 1" FR4 board.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I_D = - 250 μ A	- 60			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μΑ		68		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	iD = - 200 μΛ		- 5.2		mv/ C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 2.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zara Cata Valtaga Drain Current	1	$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	
Zero Gate Voltage Drain Current	IDSS	V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10	μA
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 25			Α
Drain-Source On-State Resistance ^a		V _{GS} = - 10 V, I _D = - 3 A		0.055		0
	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -2 \text{ A}$		0.065		Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 5 A	20			S
Dynamic ^b						
Input Capacitance	C _{iss}			1500		pF
Output Capacitance	C _{oss}	V _{DS} = - 25 V, V _{GS} = 0 V, f = 1 MHz		200		
Reverse Transfer Capacitance	C _{rss}			150		
	Qg	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -5 \text{ A}$	38		56	
Total Gate Charge				19	30	nC
Gate-Source Charge	Q _{gs}	V_{DS} = - 30 V, V_{GS} = - 4.5 V, I_{D} = - 5 A		9		
Gate-Drain Charge	Q _{gd}			10		
Gate Resistance	Rg	f = 1 MHz		5.2		Ω
Turn-On Delay Time	t _{d(on)}			10	15	
Rise Time	t _r	V_{DD} = - 2 V, R_L = 2 Ω		7	15	ns
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 5 A, V_GEN = - 10 V, R_g = 1 Ω		70	110	
Fall Time	t _f			40	60	
Drain-Source Body Diode Characteristic	s					
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			- 6.9	^
Pulse Diode Forward Current ^a	I _{SM}				- 15	A
Body Diode Voltage	V _{SD}	I _S = - 3 A		- 1	- 1.5	V
Body Diode Reverse Recovery Time	t _{rr}			45	68	ns
Body Diode Reverse Recovery Charge	Q _{rr}			59	120	nC
Reverse Recovery Fall Time	ta	I _F = - 5 A, di/dt = 10 A/μs, T _J = 25 °C		29		
Reverse Recovery Rise Time	t _b	—		16		ns

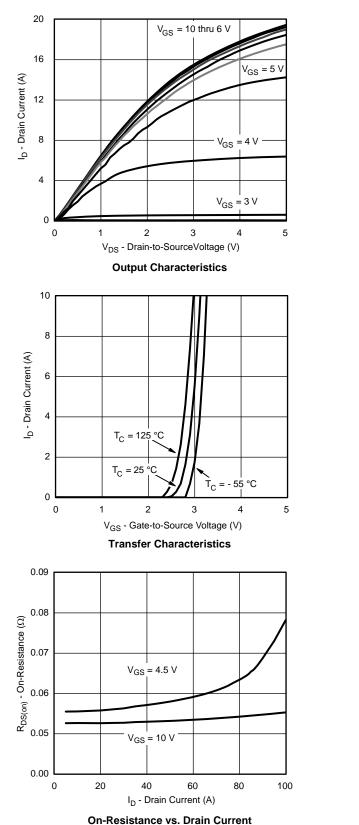
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

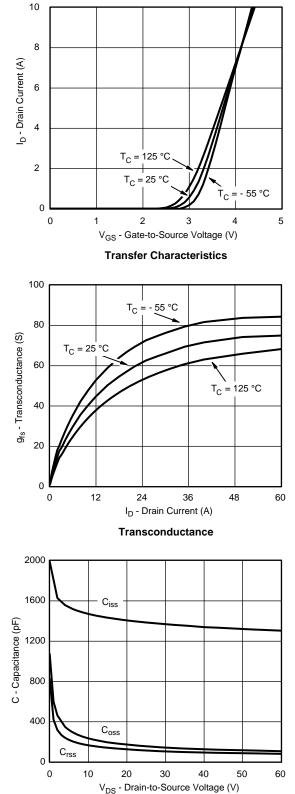
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





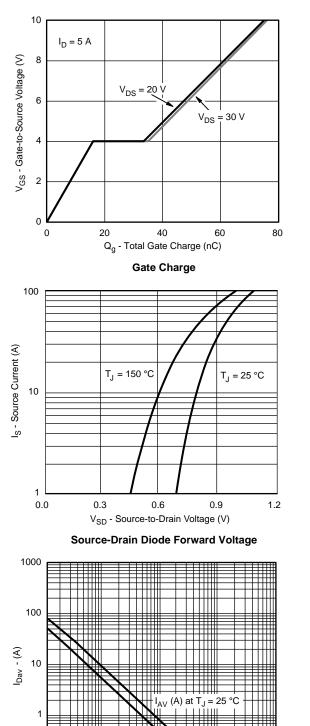
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Capacitance

服务热线:400-655-8788





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

 $\label{eq:Tin-s} T_{\text{in}} \text{-} (s)$ Single Pulse Avalanche Current Capability vs. Time

0.01

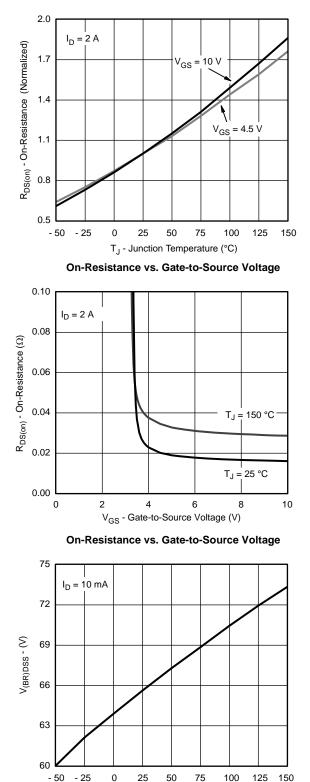
0.1

1

11111

 I_{AV} (A) at T_{J} = 150

0.001

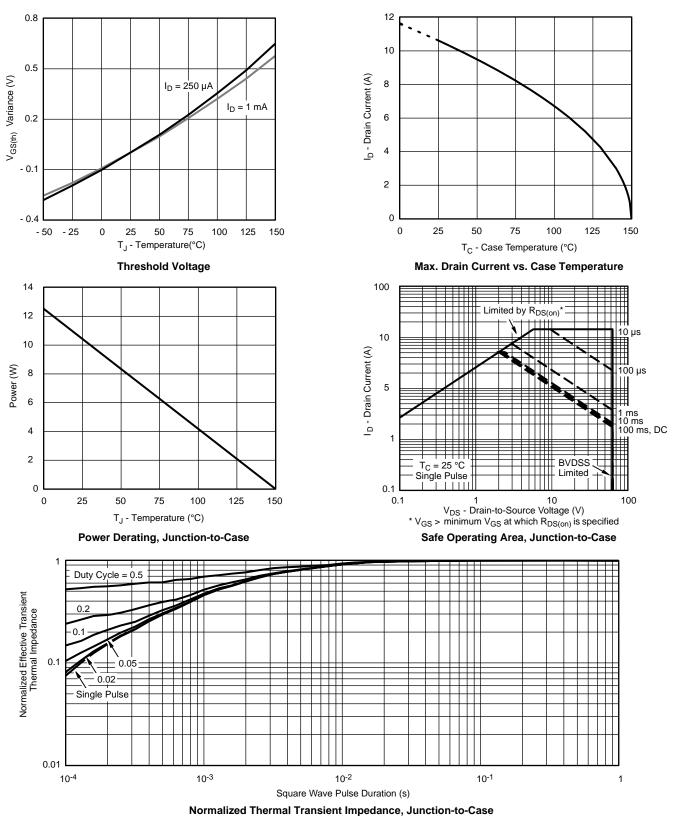


T_J - Temperature (°C) Drain-Source Breakdown Voltage vs. Junction Temperature

0.1

0.0001

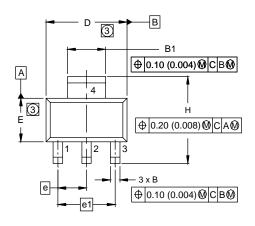


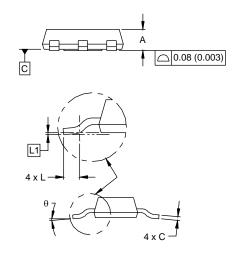


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



SOT-223 (HIGH VOLTAGE)





DIM.	MILLI	METERS		INCHES	
	MIN.	MAX.	MIN.	MAX.	
А	1.55	1.80	0.061	0.071	
В	0.65	0.85	0.026	0.033	
B1	2.95	3.15	0.116	0.124	
С	0.25	0.35	0.010	0.014	
D	6.30	6.70	0.248	0.264	
E	3.30	3.70	0.130	0.146	
е	2.30 BSC		0.0905 BSC		
e1	4.60 BSC		0.181 BSC		
Н	6.71	7.29	0.264	0.287	
L	0.91	-	0.036	-	
L1	0.061 BSC		0.002	4 BSC	
θ	-	10'	-	10'	

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension do not include mold flash.

4. Outline conforms to JEDEC outline TO-261AA.



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